

General Description

The MAX6467/MAX6468 microprocessor (µP) supervisory circuits monitor single power-supply voltages from +1.8V to +5.0V and assert a reset if the supply voltage drops below its preset threshold. An edge-triggered, one-shot manual reset function ensures that the µP enters the reset mode for a fixed timeout period only, even in the event of a continuously asserted manual reset. The MAX6467/MAX6468 significantly improve system reliability compared to traditional manual reset supervisory circuits.

A variety of factory-trimmed threshold options accommodate different supply voltages and tolerances, eliminating external components. The factory-set thresholds range from +1.575V to +4.625V to monitor +5.0V, +3.3V, +3.0V, +2.5V, and +1.8V supplies with various tolerances. Reset timeout periods of 150ms (min) and 1200ms (min) are available to accommodate different µP platforms.

A single, active-low RESET output asserts when VCC drops below its threshold or if the edge-triggered MR asserts low. RESET remains low for the reset timeout period after V_{CC} rises above its threshold and for a fixed, one-shot timeout period after a manual reset input falling edge. RESET remains valid as long as VCC remains above +1V. Open-drain (MAX6467) and push-pull (MAX6468) output options provide additional flexibility in the system design.

The MAX6467/MAX6468 are offered in the space-saving 4-pin SOT143 package and the ultra-small 4-pin SC70 package and are specified over the automotive (-40°C to +125°C) temperature range.

Applications

Cell Phones/PDAs

Embedded Control Systems

Industrial Equipment

Automotive Products

Portable/Battery-Powered Equipment

Medical Devices

DSL Modems

MP3 Players

GPS Systems

Digital Cameras

Typical Operating Circuit appears at end of data sheet.

Features

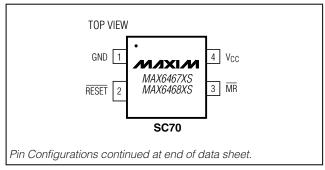
- ♦ Precision Factory-Set Reset Threshold Voltages for +5.0V, +3.3V, +3.0V, +2.5V, and +1.8V Supplies
- ♦ Edge-Triggered Manual Reset Input with One-**Shot Pulsed Reset Output**
- ♦ Two Reset Timeout Period Options (150ms or 1200ms min)
- **♦ Immune to Short Voltage Transients**
- ♦ Low Supply Current (3µA at V_{CC} = +1.8V)
- ♦ RESET Valid to V_{CC} = +1V
- ♦ Active-Low Open-Drain and Push-Pull RESET **Output Options**
- **♦** -40°C to +125°C Operating Temperature Range
- ♦ Small 4-Pin SC70 and SOT143 Packages
- ♦ No External Components Required
- ♦ Pin Compatible with MAX811, MAX6315, MAX6384, and MAX6386

Ordering Information

| PART | TEMP RANGE | PIN-PACKAGE |
|-------------|-----------------|-------------|
| MAX6467XSDT | -40°C to +125°C | 4 SC70-4 |
| MAX6467USDT | -40°C to +125°C | 4 SOT143-4 |
| MAX6468XSDT | -40°C to +125°C | 4 SC70-4 |
| MAX6468USDT | -40°C to +125°C | 4 SOT143-4 |

Note: Insert reset threshold suffix (see Reset Threshold table) after XS or US. Insert reset timeout delay (see Reset Timeout Delay table) after D to complete the part number. Sample stock is generally held on standard versions only (see Standard Versions table). Standard versions have an order increment requirement of 2500 pieces. Nonstandard versions have an order increment requirement of 10,000 pieces. Contact factory for availability.

Pin Configurations



NIXIN

Maxim Integrated Products 1

ABSOLUTE MAXIMUM RATINGS

| V _{CC} to GND | 0.3V to +6.0V |
|-------------------------|----------------------------------|
| RESET to GND | |
| Open-Drain | 0.3V to +6.0V |
| Push-Pull | 0.3V to (V _{CC} + 0.3V) |
| MR to GND | 0.3V to (V _{CC} + 0.3V) |
| Input/Output Current (a | all pins)20mA |
| | |

| $T_A = +70^{\circ}C$ |
|----------------------|
| C above +70°C)245mW |
| C above +70°C)320mW |
| 40°C to +125°C |
| 65°C to +150°C |
| +150°C |
| 0s)+300°C |
| |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{CC} = +1.2V \text{ to } +5.5V, T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at $T_A = +25^{\circ}\text{C}.)$ (Note 1)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | |
|---|------------------|--|------------------------|-----------------|-----------------------|-------|--|
| Operating Voltage Bange | \/ | $T_A = 0$ °C to +125°C | 1.0 | | 5.5 | V | |
| Operating Voltage Range | Vcc | $T_A = -40$ °C to 0°C | 1.2 | | 5.5 |] V | |
| | | V _{CC} = +5.5V, no load | | 7 | 13 | | |
| | | V _{CC} = +3.6V, no load | | 6 | 11 | | |
| Supply Current | Icc | V _{CC} = +2.5V, no load | | 4 | 8 | μΑ | |
| | | $V_{CC} = +1.8V$, no load | | 3 | 7.5 | | |
| | | T _A = +25°C | -1.5% | V _{TH} | +1.5% | | |
| V _{CC} Reset Threshold (See the Reset Threshold Table) | V _{TH} | $T_A = -40$ °C to $+85$ °C | -2.5% | | +2.5% | V | |
| (See the neset Theshold Table) | | T _A = +85°C to +125°C | -3% | | +3% | | |
| V _{CC} Reset Delay | t _{RD} | V _{CC} falling at 10mV/µs from V _{TH} + 100mV to V _{TH} - 100mV | | 35 | | μs | |
| V D .T .D | | D3 option | 150 | 225 | 300 | | |
| V _{CC} Reset Timeout Period | t _{RP} | D7 option | 1200 | 1800 | 2400 | ms | |
| MR Timeout Period | t _{MRP} | D3 and D7 options | 150 | 225 | 300 | ms | |
| MR Rising Debounce Period (Note 2) | t _{DEB} | D3 and D7 options | 150 | 225 | 300 | ms | |
| | VIL | | | (| 0.3 x V _{CC} | | |
| 100 1 | VIH | V _{TH} < +4V | 0.7 x V _{CC} | | | | |
| MR Input Voltage | V _{IL} | | | | 0.8 | V | |
| | VIH | V _{TH} ≥ +4V | 2.4 | | | | |
| MR Minimum Input Pulse | | | 1 | | | μs | |
| MR Glitch Rejection | | | | 100 | | ns | |
| MR to RESET Delay | | | | 200 | | ns | |
| MR Pullup Resistance | | MR to V _{CC} | 750 | 1500 | 2250 | Ω | |
| RESET Output High | Vou | V _{CC} ≥ +2.5V, I _{SOURCE} = 500μA, RESET not asserted 0.8 x V _{CC} | | | V | | |
| (MAX6468 Only) | Voн | V _{CC} ≥ +4.5V, I _{SOURCE} = 800µA, RESET not asserted | 0.8 x V _C C | ; | | V | |

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ELECTRICAL CHARACTERISTICS (continued)

 $(V_{CC} = +1.2V \text{ to } +5.5V, T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}, \text{ unless otherwise noted.}$ Typical values are at $T_A = +25^{\circ}\text{C}.)$ (Note 1)

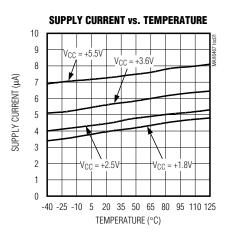
| PARAMETER SYMBOL CONDITIONS | | MIN | TYP | MAX | UNITS | |
|---|------------------|--|-----|-----|-------|----|
| RESET Output Low | VoL | V _{CC} ≥ +1V, I _{SINK} = 80µA, RESET asserted | | | 0.3 | |
| | | V _{CC} ≥ +2.5V, I _{SINK} = 1.2mA, RESET asserted | | | 0.3 | V |
| | | V _{CC} ≥ +4.5V, I _{SINK} = 3.2mA, RESET asserted | | | 0.3 | |
| RESET Output Leakage Current (MAX6467 Only) | I _{LKG} | RESET not asserted | | | 1 | μA |

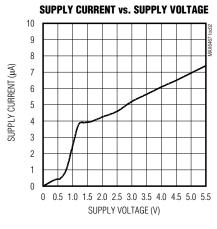
Note 1: Specifications over temperature are guaranteed by design. Production testing at $T_A = +25$ °C only

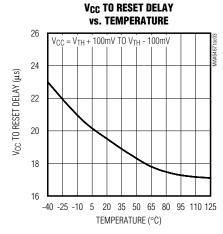
Note 2: The \overline{MR} input ignores falling edges that occur within the \overline{MR} rising debounce period (tDEB) after \overline{MR} first rises from low to high (after a valid \overline{MR} reset assertion). This prevents invalid reset assertion due to switch bounce.

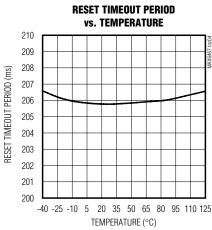
Typical Operating Characteristics

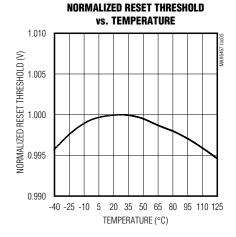
($V_{CC} = +5V$, MAX6468US29D3 device, $T_A = +25$ °C, unless otherwise noted.)

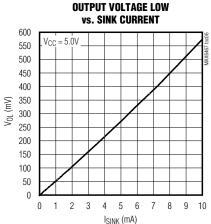






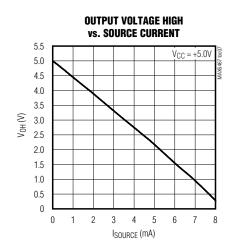


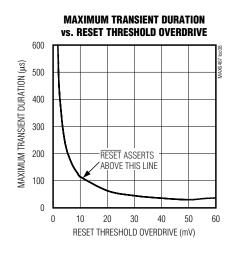


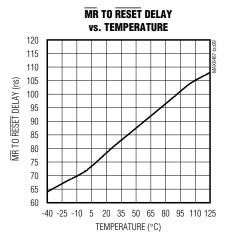


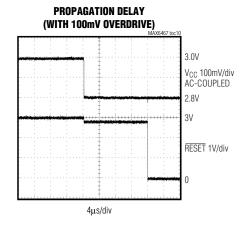
Typical Operating Characteristics (continued)

 $(V_{CC} = +5V, MAX6468US29D3 device, T_A = +25^{\circ}C, unless otherwise noted.)$

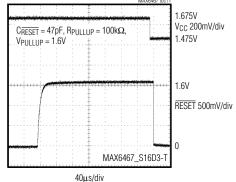


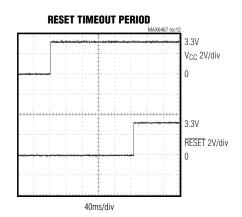












Pin Description

| PIN | NAME | FUNCTION |
|-----|------------------|--|
| 1 | GND | Ground |
| 2 | RESET | Reset Output. RESET is an active-low open-drain (MAX6467) or push-pull (MAX6468) output. RESET asserts low when V _{CC} drops below the selected threshold and remains low for the V _{CC} reset timeout period after V _{CC} rises above the threshold. The RESET one-shot asserts low for a fixed MR reset timeout period on the falling edge of the manual reset input. The open-drain output requires an external pullup resistor. |
| 3 | MR | Manual Reset Input. Drive $\overline{\text{MR}}$ low to initiate a reset output. $\overline{\text{MR}}$ controls an edge-triggered one-shot that asserts $\overline{\text{RESET}}$ low for a fixed $\overline{\text{MR}}$ timeout period when $\overline{\text{MR}}$ is driven low. Internal timing circuitry ignores switch close and open bounce to ensure proper one-shot reset timing. |
| 4 | V _C C | Power-Supply Input. V _{CC} provides power to the device and is also a monitored voltage. When V _{CC} drops below the selected threshold, RESET asserts low and remains low for the reset timeout period after V _{CC} rises above the threshold. For better noise immunity, bypass V _{CC} to GND with a 0.1µF capacitor. |

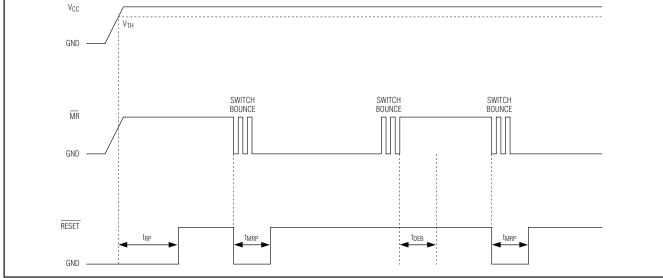


Figure 1. Timing Diagram

Detailed Description

Reset Output

The MAX6467 provides an active-low open-drain RESET output. The MAX6468 provides an active-low push-pull RESET output. RESET asserts low if VCC drops below the selected threshold or if a falling edge occurs on MR. RESET remains low for the VCC reset timeout period after VCC increases above the threshold voltage or is one-shot pulsed low for the MR timeout period after a falling edge on MR.

Manual Reset Input

Many μP -based products require manual reset capability, allowing the operator, a test technician, or external logic circuitry to initiate a reset. A falling edge on \overline{MR} asserts

RESET low. RESET is one-shot pulsed low for the MR timeout period after a falling edge on MR. An internal $1.5k\Omega$ pullup resistor to VCC allows MR to be left unconnected if not used. MR can be driven with TTL or CMOSlogic levels, or with open-drain/collector outputs. Connect a normally open momentary pushbutton switch from MR to GND to realize a manual reset function. External debounce circuitry is not required, as the MAX6467/ MAX6468 respond to the first falling edge on MR and ignore subsequent falling edges within the reset timeout period and during the MR debounce period (see Figure 1). After MR goes high for 150ms (tDEB), the manual reset one-shot is ready to trigger a reset on the next MR falling edge. Connect a 0.1µF capacitor from MR to GND when using long cables to provide additional noise immunity (Figure 2).

Reset Timeout Delay*

| RESET TIMEOUT SUFFIX | V _{CC} RESET TIMEOUT PERIOD (min/max) (ms) | MR TIMEOUT PERIOD (min/max) (ms) | MR RISING DEBOUNCE PERIOD (min/max) (ms) |
|----------------------|---|----------------------------------|--|
| D3 | 150/300 | 150/300 | 150/300 |
| D7 | 1200/2400 | 150/300 | 150/300 |

^{*}Additional reset timeout options may be available. Contact factory for availability.

Applications Information

Falling VCC Transients

In addition to issuing a reset to the μP during power-up, power-down, and brownout conditions, the MAX6467/MAX6468 are relatively immune to short-duration falling VCC transients (glitches). The *Typical Operating Characteristics* section shows the Maximum Transient Duration vs. VCC Overdrive for which the MAX6467/MAX6468 do not generate a reset pulse. This graph was generated using a falling pulse applied to VCC starting above the actual reset threshold and ending below the threshold by the magnitude indicated (VCC Overdrive). The graph indicates the typical maximum pulse width a falling VCC transient can have without initiating a reset pulse. As the magnitude of the transient increases (goes

farther below the reset threshold), the maximum allowable pulse width decreases. A $0.1\mu F$ bypass capacitor from VCC to GND provides additional transient immunity.

Ensuring a Valid RESET Output Down to Vcc = 0V

The MAX6467/MAX6468 guarantee proper operation down to V_{CC} = +1V. In applications that require valid reset levels down to V_{CC} = 0V, a pulldown resistor to active-low outputs (MAX6468 only, Figure 3) ensures that RESET remains valid while the RESET output can no longer sink current. This scheme does not work with the open-drain outputs of the MAX6467. Ensure that the resistor value used does not overload the RESET output when V_{CC} is above the reset threshold. For most applications, use 100k Ω to 1M Ω .

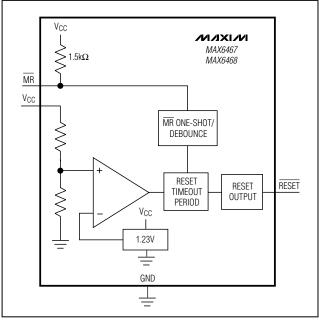


Figure 2. Functional Diagram

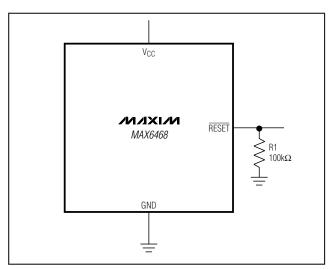


Figure 3. \overline{RESET} Valid to $V_{CC} = 0V$

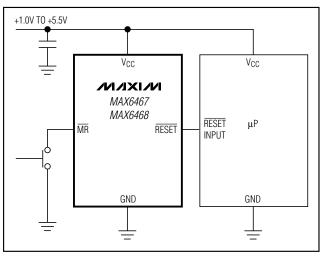
Chip Information

TRANSISTOR COUNT: 748
PROCESS: BICMOS

Standard Versions

| PART | TOP MARK | |
|--------------------|----------|--|
| MAX6467XS16D3 | AGL | |
| MAX6467XS22D3 | AGM | |
| MAX6467XS26D3 | AGN | |
| MAX6467XS29D3 | AGO | |
| MAX6467XS46D3 | AGP | |
| MAX6467US16D3 | KAFN | |
| MAX6467US22D3 | KAFO | |
| MAX6467US26D3 | KAFP | |
| MAX6467US29D3 | KAFQ | |
| MAX6467US46D3 | KAFR | |
| MAX6468XS16D3 | AGQ | |
| MAX6468XS22D3 | AGR | |
| MAX6468XS26D3 | AGS | |
| MAX6468XS29D3 | AGC | |
| MAX6468XS46D3 | AGB | |
| MAX6468US16D3 KAFS | | |
| MAX6468US22D3 | KAFT | |
| MAX6468US26D3 | KAFU | |
| MAX6468US29D3 | KAEW | |
| MAX6468US46D3 | KAFV | |

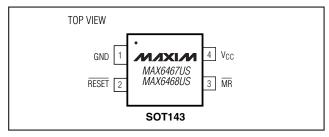
Typical Operating Circuit



Reset Threshold (-40°C to +85°C)

| | | | 1 |
|--------|-----------------------|-----------------------|-----------------------|
| SUFFIX | V _{TH} (min) | V _{TH} (typ) | V _{TH} (max) |
| 46 | 4.509 | 4.625 | 4.741 |
| 45 | 4.388 | 4.500 | 4.613 |
| 44 | 4.266 | 4.375 | 4.484 |
| 43 | 4.193 | 4.300 | 4.408 |
| 42 | 4.095 | 4.200 | 4.305 |
| 41 | 3.998 | 4.100 | 4.203 |
| 40 | 3.900 | 4.000 | 4.100 |
| 39 | 3.803 | 3.900 | 3.998 |
| 38 | 3.705 | 3.800 | 3.895 |
| 37 | 3.608 | 3.700 | 3.793 |
| 36 | 3.510 | 3.600 | 3.690 |
| 35 | 3.413 | 3.500 | 3.588 |
| 34 | 3.315 | 3.400 | 3.485 |
| 33 | 3.218 | 3.300 | 3.383 |
| 32 | 3.120 | 3.200 | 3.280 |
| 31 | 2.998 | 3.075 | 3.152 |
| 30 | 2.925 | 3.000 | 3.075 |
| 29 | 2.852 | 2.925 | 2.998 |
| 28 | 2.730 | 2.800 | 2.870 |
| 27 | 2.633 | 2.700 | 2.768 |
| 26 | 2.559 | 2.625 | 2.691 |
| 25 | 2.438 | 2.500 | 2.563 |
| 24 | 2.340 | 2.400 | 2.460 |
| 23 | 2.255 | 2.313 | 2.370 |
| 22 | 2.133 | 2.188 | 2.242 |
| 21 | 2.048 | 2.100 | 2.153 |
| 20 | 1.950 | 2.000 | 2.050 |
| 19 | 1.853 | 1.900 | 1.948 |
| 18 | 1.755 | 1.800 | 1.845 |
| 17 | 1.623 | 1.665 | 1.707 |
| 16 | 1.536 | 1.575 | 1.614 |

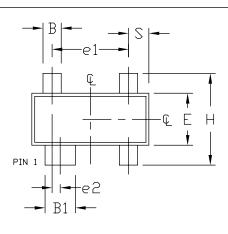
Pin Configurations (continued)



Package Information

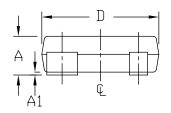
MILLIMETERS

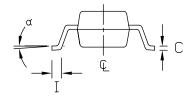
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



| MIN | MAX | MIN | MAX |
|--------|---|--|--|
| 0.031 | 0.047 | 0.787 | 1.194 |
| 0.001 | 0.005 | 0.025 | 0.127 |
| 0.014 | 0.022 | 0.356 | 0.559 |
| 0.030 | 0.038 | 0.762 | 0,965 |
| 0.0034 | 0.006 | 0.086 | 0.152 |
| 0.105 | 0.120 | 2.667 | 3.048 |
| 0.047 | 0.055 | 1.194 | 1.397 |
| 0.071 | 0.079 | 1.803 | 2.007 |
| 0.008 | BSC | 0.200 BSC | |
| 0.082 | 0.098 | 2.083 | 2,489 |
| 0.004 | 0.012 | 0.102 | 0.305 |
| 0.018 | 0.024 | 0.450 | 0.600 |
| 0- | 8- | 0- | 8- |
| | 0.031 0.001 0.014 0.030 0.0034 0.105 0.047 0.071 0.008 0.082 0.004 0.018 | 0.031 0.047 0.001 0.005 0.014 0.022 0.030 0.038 0.0034 0.006 0.105 0.120 0.047 0.055 0.071 0.079 0.082 0.098 0.004 0.012 0.018 0.024 | 0.031 0.047 0.787 0.001 0.005 0.025 0.014 0.022 0.356 0.030 0.038 0.762 0.0034 0.006 0.086 0.105 0.120 2.667 0.047 0.055 1.194 0.071 0.079 1.803 0.008 BSC 0.200 0.082 0.098 2.083 0.004 0.012 0.102 0.018 0.024 0.450 |

INCHES





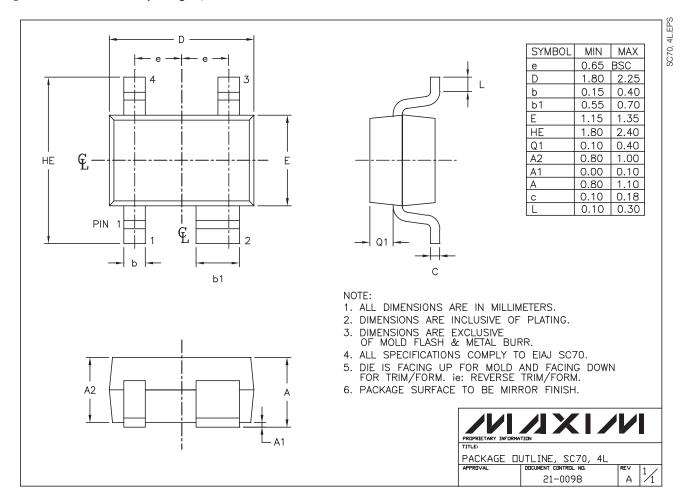
NOTES:

- 1. D&E DO NOT INCLUDE MOLD FLASH.
- 2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED .15mm (.006").
- 3. CONTROLLING DIMENSION: MILLIMETERS.
- 4. MEETS JEDEC TO253.



Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



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